<b>PCN Number:</b> 20180223		001 PCN Date:		Febr	February 26, 2018	
Title: Datasheet fo	r LM5113					
<b>Customer Contact:</b>	PCN Manag	<u>ier</u>		De	ept:	Quality Services
Change Type:						
Assembly Site		Desi			_	r Bump Site
Assembly Process			Sheet		_	r Bump Material
Assembly Materials		Part number change				r Bump Process
Mechanical Specification		Test Site		$\perp \mid \perp \mid$		r Fab Site
Packing/Shipping/Labeling		Test Process				r Fab Materials
		Notification Details			ware	r Fab Process
Description of Chang	ie:	NOTITIO	cation Details			
Texas Instruments Inco		announci	ng an information of	only n	otificati	on.
The product datasheet					o cirroa ci	
The following change h						
TEXAS						
TEXAS INSTRUMENTS				CNIVC	7254 1110	<b>LM5113</b> E 2011–REVISED JANUARY 2018
				SINVS	725H <b>-</b> JUN	E 2011-REVISED JANUART 2016
Changes from Revision G	(January 2016)	to Revision	Н			Page
Changed data sheet title	from: LM5113 1	00 V 1.2-A /	5-A, Half-Bridge Gate D	river for	Enhance	ment Mode GaN
<ul> <li>Changed data sheet title from: LM5113 100 V 1.2-A / 5-A, Half-Bridge Gate Driver for Enhancement Mode GaN FETs to: LM5113 80-V, 1.2-A, 5-A, Half Bridge GaN Driver (NRND)</li></ul>						
Added Not Recommended for New Designs statement to the data sheet						
Added content to the <i>Description</i> section						
Changed the first page key graphic						
Removed HB to VDD parameter from the Absolute Maximum Ratings table						
Changed the HS to VSS maximum from: 100 V to: 93 V						
Changed the HB to VSS maximum from: 107 V to: V(HS) + 7 V						
Changed the human-body model value from: ±2000 to: ±1000						
	Changed the Functional Block Diagram					
Added content to the Start-up and UVLO section						
The datasheet number	will be chan	iging.				
Device Family			Change From:		Chang	je To:
LM5113			SNVS725G		SNVS	725H
				<u>ــــــــــــــــــــــــــــــــــــ</u>		
These changes may be			sneet iinks provide	u.		
http://www.ti.com/product/LM5113						
Reason for Change:						
To accurately reflect de	evice charact	teristics.				
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):						
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.						
Changes to product identification resulting from this PCN:						
None.						
Product Affected:						

LM5113SD/NOPB	LM5113SDE/NOPB	LM5113SDX/NOPB	LM5113TME/NOPB
LM5113TMX/NOPB			

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail			
USA	PCNAmericasContact@list.ti.com			
Europe	PCNEuropeContact@list.ti.com			
Asia Pacific	PCNAsiaContact@list.ti.com			
Japan	PCNJapanContact@list.ti.com			